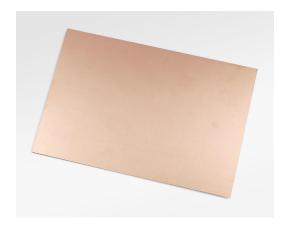


## Plain Copper FR4 Single & Double Sided Fibre Glass Laminate



Raw Copper Clad Double/Single Sided Laminate PCB material ideal for use with CNC Isolation Routing Drilling Machines, Dry Film Laminators, Screen Printed Resists, LDI Laser Direct Imaging or Etch resist transfers or ink Etch Resist pen. Manufactured and tested in accordance with IPC4101C/21.

Suitable etchants include Ferric Chloride or Fine Etch Crystals.

Specifications:	
Thickness	1.6mm FR4 Epoxy Glass Laminate
Copper foil	35/00 Micron 1oz Single Sided 35/35 Micron 1/1oz Double Sided
Dissipation factor	35
Dielectric constant	5.4
Solderbath resistance (260°C)	20 secs

## Standard sizes available:-

160 x 100 x 1.6mm	(35/00um Single Sided and 35/35 Double Sided)
100 x 220 x 1.6mm	(35/00um Single Sided and 35/35 Double Sided)
203 x 114 x 1.6mm	(35/00um Single Sided and 35/35 Double Sided)
233.4 x 160 x 1.6mm	(35/00um Single Sided and 35/35 Double Sided)
	(35/00um Single Sided and 35/35 Double Sided)
305 x 457 x 1.6mm	(35/00um Single Sided and 35/35 Double Sided)
510 x 11150 x 1.6mm	(35/00um Single Sided and 35/35 Double Sided)

Other sizes and thicknesses available by request